

NPN 100mA 50V Digital Transistor (Bias Resistor Built-in Transistor)

Parameter	Value
V <sub>CC</sub>	50V
I <sub>C(MAX.)</sub>	100mA
R <sub>1</sub>	100kΩ
R <sub>2</sub>	100kΩ

#### Features

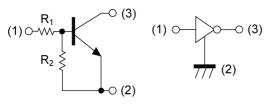
- 1) Built-In Biasing Resistors,  $R_1 = R_2 = 100 \text{k}\Omega$
- 2) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary PNP Types: DTA115E series

## Application

INVERTER, INTERFACE, DRIVER

#### •Inner circuit

DTC115EM/ DTC115EEB/ DTC115EUB

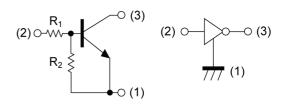


- (1) IN (BASE)
- (2) GND (EMITTER)
- (3) OUT (COLLECTOR)

## Outline

- Outilitie	
SOT-723	SOT-416FL
DTC115EM (VMT3)	DTC115EEB (EMT3F)
SOT-416	SOT-323FL
DTC115EE (EMT3)	DTC115EUB (UMT3F)
SOT-323	SOT-346
DTC115EUA (UMT3)	DTC115EKA (SMT3)

## DTC115EE/ DTC115EUA/ DTC115EKA



- (1) GND (EMITTER)
- (2) IN (BASE)
- (3) OUT (COLLECTOR)

## Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTC115EM	SOT-723	1212	T2L	180	8	8000	29
DTC115EEB	SOT-416FL	1616	TL	180	8	3000	29
DTC115EE	SOT-416	1616	TL	180	8	3000	29
DTC115EUB	SOT-323FL	2021	TL	180	8	3000	29
DTC115EUA	SOT-323	2021	T106	180	8	3000	29
DTC115EKA	SOT-346	2928	T146	180	8	3000	29

## ● **Absolute maximum ratings** (T<sub>a</sub> = 25°C)

Par	ameter	Symbol	Values	Unit
Supply voltage		V <sub>CC</sub>	50	V
Input voltage		V <sub>IN</sub>	-10 to 40	V
Output current		Io	20	mA
Collector current			100	mA
	DTC115EM		150	
		150		
Davies dia in eties	DTC115EE	$P_{D}^{*2}$	150	mW
Power dissipation	DTC115EUB	P <sub>D</sub> -	200	
	DTC115EUA		200	
	DTC115EKA		200	
Junction temperature		T <sub>j</sub>	150	°C
Range of storage temperatu	re	T <sub>stg</sub>	-55 to +150	°C

# ● Electrical characteristics (T<sub>a</sub> = 25°C)

Parameter	Symbol	Conditions	Values			Unit
- Farameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Input voltage	$V_{l(off)}$	$V_{CC} = 5V, I_{O} = 100 \mu A$	-	-	0.5	V
Input voltage	V <sub>I(on)</sub>	V <sub>O</sub> = 0.3V, I <sub>O</sub> = 1mA	3.0	-	-	V
Output voltage	V <sub>O(on)</sub>	I <sub>O</sub> = 5mA, I <sub>I</sub> = 0.25mA	-	100	300	mV
Input current	l <sub>l</sub>	V <sub>I</sub> = 5V	1	-	150	μA
Output current	I <sub>O(off)</sub>	$V_{CC} = 50V, V_{I} = 0V$	1	-	500	nA
DC current gain	G <sub>I</sub>	$V_{O} = 5V, I_{O} = 5mA$	82	-	-	-
Input resistance	R <sub>1</sub>	-	70	100	130	kΩ
Resistance ratio	R <sub>2</sub> /R <sub>1</sub>	-	0.8	1.0	1.2	-
Transition frequency	f <sub>T</sub> *1	$V_{CE} = 10V, I_{E} = -5mA,$ f = 100MHz	-	250	-	MHz

<sup>\*1</sup> Characteristics of built-in transistor

<sup>\*2</sup> Each terminal mounted on a reference land

## ● Electrical characteristic curves (T<sub>a</sub> =25°C)

Fig.1 Input voltage vs. output current (ON characteristics)

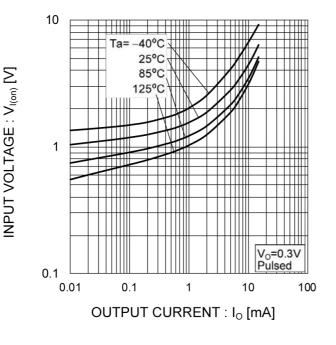


Fig.2 Output current vs. input voltage (OFF characteristics)

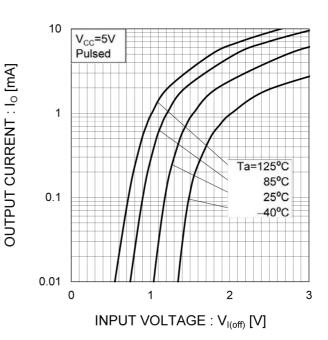


Fig.3 Output current vs. output voltage

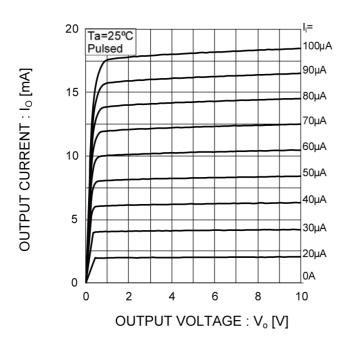
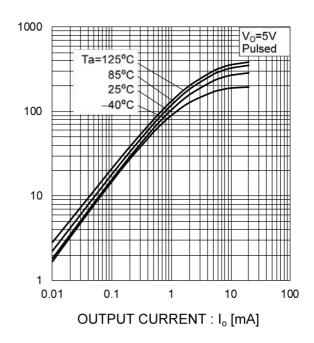


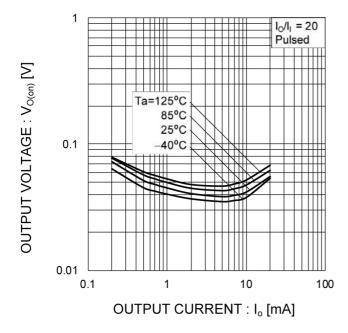
Fig.4 DC current gain vs. output current

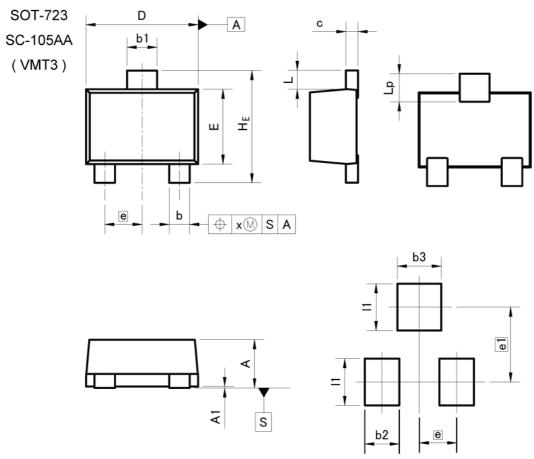


DC CURRENT GAIN: G

# ●Electrical characteristic curves (T<sub>a</sub> =25°C)

Fig.5 Output voltage vs. output current





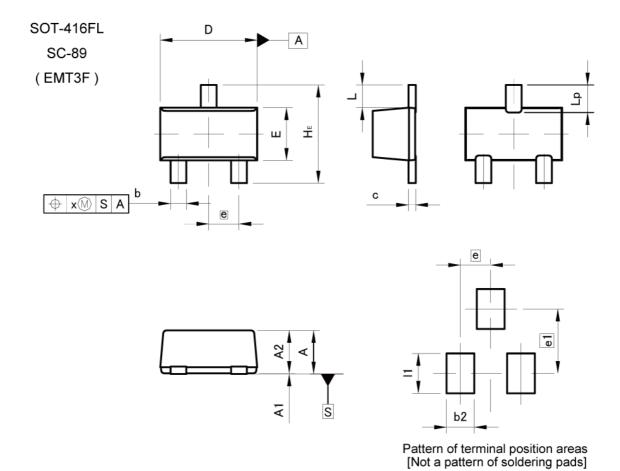
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM [	MIN	MAX	MIN	MAX
Α	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
b1	0.27	0.37	0.011	0.015
С	0.08	0.18	0.003	0.007
D	1.10	1.30	0.043	0.051
E	0.70	0.90	0.028	0.035
е	0.4	40	0.0	02
HE	1.10	1.30	0.043	0.051
L	0.10	0.30	0.004	0.012
Lp	0.20	0.40	0.008	0.016
х	#	0.10	<u> </u>	0.004

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
b2	<u> </u>	0.37	544	0.015
b3	223	0.47	822	0.019
e1	0.	80	0.031	
11	<del>5</del> 98	0.50	250	0.020

Dimension in mm/inches



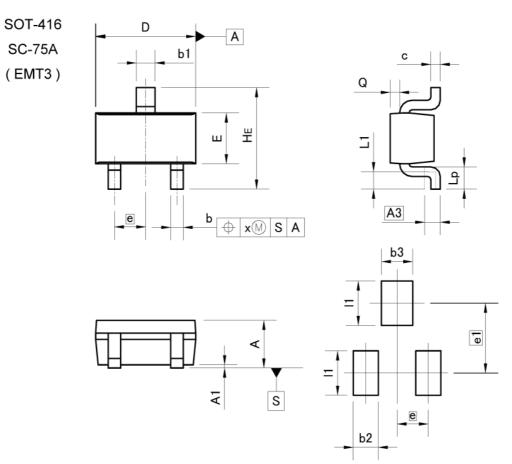


DIM -	MILIM	ETERS	INC	HES
DIM [	MIN	MAX	MIN	MAX
Α	0.65	0.85	0.026	0.033
A1	0.00	0.10	0.000	0.004
A2	0.60	0.80	0.024	0.031
b	0.21	0.36	0.008	0.014
С	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	0.76	0.96	0.030	0.038
е	0.	0.50 0.020		20
HE	1.50	1.70	0.059	0.067
L	0.3	37	0.0	15
Lp	0.35	0.55	0.014	0.022
х		0.10	-	0.004

DIM -	MILIMETERS		INCHES	
DIM [	MIN	MAX	MIN	MAX
b2	<del>=</del> 1	0.46	_	0.018
e1	4:	1.05	-	0.041
11	=	0.65	=	0.026

Dimension in mm/inches





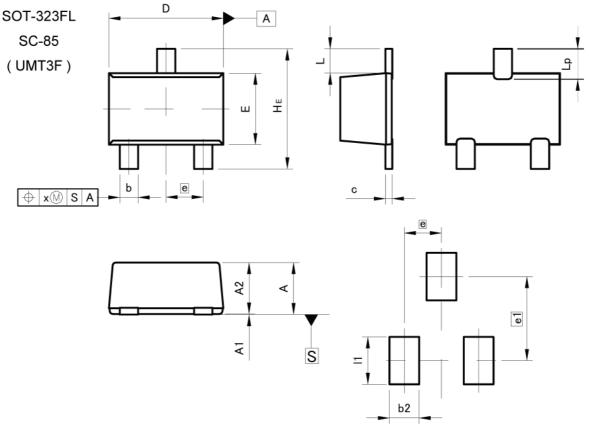
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM [	MIN	MAX	MIN	MAX
Α	0.60	0.80	0.024	0.031
A1	0.00	0.10	0.000	0.004
A3	0.	0.25		10
b	0.15	0.30	0.006	0.012
b1	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
E	0.70	0.90	0.028	0.035
е	0.	50	0.020	
HE	1.40	1.80	0.055	0.071
L1	0.10	<u>#</u> 3	0.004	S <del>#</del>
Lp	0.15		0.006	25 <del>18</del>
Q	0.05	0.25	0.002	0.010
x	9,55	0.10	_	0.004

DIM -	MILIMETERS		INCHES	
DIM L	MIN	MAX	MIN	MAX
b2	244	0.40	-	0.016
b3	10 <del>48</del>	0.50	; <del>; ; ; ; ; ; ; ; ; ; ; ; ; ; ; ; ; ; </del>	0.020
e1	1.	10	0.0	043
11		0.70	-	0.028

Dimension in mm/inches





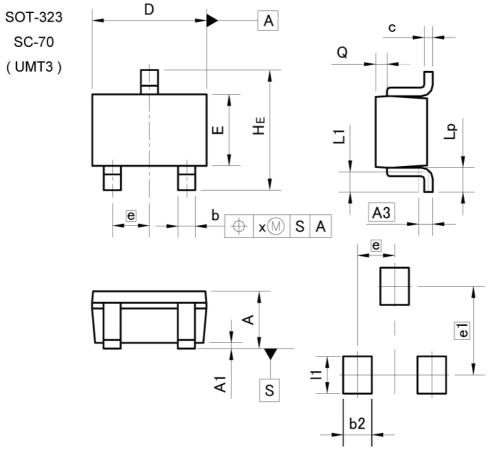
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM -	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.85	1.05	0.033	0.041
A1	0.00	0.10	0.000	0.004
A2	0.80	1.00	0.031	0.039
b	0.27	0.42	0.011	0.017
С	0.08	0.18	0.003	0.007
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.0	65	0.0	26
HE	2.00	2.20	0.079	0.087
L	0.4	25	0.0	17
Lp	0.43	0.63	0.017	0.025
х	==:	0.10	-	0.004

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
b2	<del>-</del> s	0.52	-	0.020
e1	1.47		0.058	
11	<del></del>	0.83	-	0.033

Dimension in mm/inches





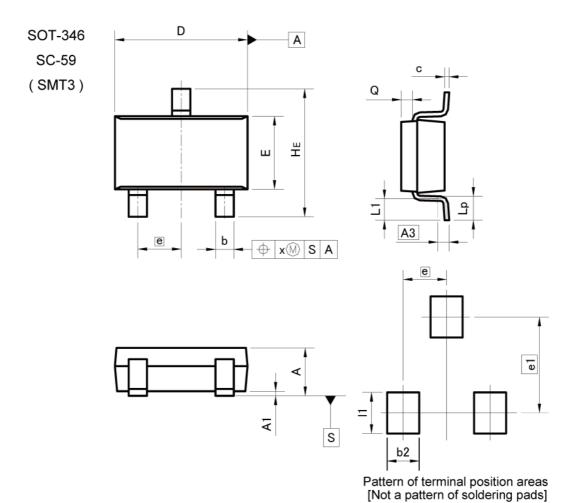
Pattern of terminal position areas [Not a pattern of soldering pads]

DIM -	MILIMETERS		INCHES	
DIM [	MIN	MAX	MIN	MAX
Α	0.80	1.00	0.031	0.039
A1	0.00	0.10	0.000	0.004
A3	0.25		0.010	
b	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.65		0.0	26
HE	2.00	2.20	0.079	0.087
L1	0.10	0.40	0.004	0.016
Lp	0.25	0.55	0.010	0.022
Q	0.10	0.30	0.004	0.012
х	=	0.10	-	0.004

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
b2	<u>644</u> 9	0.50	<u>~=</u>	0.020
e1	1.55		0.061	
11	<del>-</del>	0.65	1000	0.026

Dimension in mm/inches





DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	1.00	1.30	0.039	0.051
A1	0.00	0.10	0.000	0.004
A3	0.25		0.010	
b	0.35	0.50	0.014	0.020
С	0.09	0.25	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
е	0.95		0.037	
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.20	0.30	0.008	0.012
х	7,8	0.10	\$ <del>5</del>	0.004
У	=0	0.10	97	0.004

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
b2	-2	0.60	×=	0.024
e1	2.10		0.083	
11	-8	0.90	<del>(=</del>	0.035

Dimension in mm/inches



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### **Precaution on using ROHM Products**

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JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSIII	CLASS II b	CLASSIII
CLASSIV	CLASSIII	CLASSIII	CLASSIII

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  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### **Precaution for Mounting / Circuit board design**

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

### **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
  may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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Notice-PGA-E Rev.003

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NSBC114YF3T5G NSBC123TF3T5G SMUN5235T1G SMUN5330DW1T1G SSVMUN5312DW1T2G RN1303(TE85L,F)

RN4605(TE85L,F) TTEPROTOTYPE79 DDTC114EUAQ-7-F EMH15T2R SMUN2214T3G NSBC114TF3T5G NSBC143ZPDP6T5G

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NSVDTA114EET1G 2SC2223-T1B-A 2SC3912-TB-E SMUN5237DW1T1G SMUN5213DW1T1G SMUN5114DW1T1G SMUN2111T1G

NSVDTC144EM3T5G DTC124ECA-TP DTC123TM3T5G DTA114ECA-TP DTA113EM3T5G DCX115EK-7-F DTC113EM3T5G

NSVMUN5135DW1T1G NSVMUN2237T1G SMUN5335DW1T2G